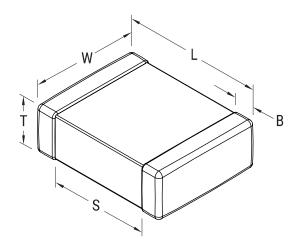


## C1206F224M1RAC7210

SMD Comm X7R FO, Ceramic, 0.22 uF, 20%, 100 VDC, X7R, SMD, MLCC, Open Mode, Temperature Stable, 1206, 1.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X7R FO
Style	SMD Chip
Description	SMD, MLCC, Open Mode, Temperature Stable
Features	Open Mode, Temperature Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	25 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		s
Chip Size	1206	C
L	3.2mm +/-0.2mm	Ν
W	1.6mm +/-0.2mm	٦
т	1mm +/-0.20mm	١
S	1.5mm MIN	0
В	0.5mm +/-0.25mm	Т
		т

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	10000

Specifications	
Capacitance	0.22 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	20%
Voltage DC	100 VDC
Dielectric Withstanding Voltage	250 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	4.5455 GOhms

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